



CR200A-02B3-H BISHOP-3 200mm Wafer Carrier

Pozzetta will protect your valuable products from particles, ESD damage, outgassed components, and high costs. Companies around the world trust Pozzetta to create secure environments for the semiconductor, electronics, and medical industries.

Dimensions

Capacity: 25

Overall Size: 234mm x 203mm x 219mm

D₁ Dimension – distance from the H-shaped end surface to the center line of the first pocket (SEMI Std): 25.4mm

Pocket Spacing – The distance between pocket center lines: 6.35mm

Pocket Flat – The width of the pocket at its narrowest distance: 2.0mm

Features and Benefits

- H-shaped end for equipment interface.
- E-shaped handle on end wall.
- Wash slots in side walls.
- Excellent heat resistance and rigidity.
- Improved predictability of wafer location in the horizontal plane.

Material Description

BISHOP-3 is a conductive high performance resin that provides excellent heat resistance for long periods, chemical resistance and dimensional stability. Extremely low outgassing.

CR200A-02B3-H

